# POLYSWITCH® Resettable PTCs

Surface Mount > LoRho Series



PO HE RoHS COLUS

## LoRho SMD PTC for Charging Cable Protection



#### **Agency Approvals**

AGENCY	AGENCY FILE NUMBER	AMPERE RANGE
c 🂫 us	E74889*	4.5A
$\boldsymbol{\triangle}$	J 50313999*	4.5A

\* See Electrical Characteristic Table for approved part numbers.

#### Applications

- Over temperature (OT) protection for USB connectors and cables including:
- USB Type-C
- USB Micro-B
- USB-A

- Fast charging standards and protocols including:
  - USB Power Delivery (PD) <sup>+</sup>
- Qualcomm Quick
   Charge (QC) <sup>†</sup>
- Mediatek Pump
   Express (PE) <sup>+</sup>
- Samsung Adaptive
   Fast Charging (AFC) <sup>+</sup>
- Huawei/HiSilicon Fast
   Charging Protocol (FCP) <sup>+</sup>

<sup>+</sup>These charging protocols are the property of their respective owners.

#### **Electrical Characteristics**

Part Number	Marking	Marking	ا 1 ا <sub>hold</sub>	V <sub>max</sub> <sup>2</sup>			Therma (TCO) -		P <sub>d</sub> ³typ.	Resis	tance	•	ency ovals
Part Number		(A)	(Vdc)	Min	Max	Min	Max	(W)	${{R_{\min}}^4}{(\Omega)}$	R <sub>1max</sub> <sup>5</sup> (Ω)	c R <sup>°</sup> us	$\triangle$	
nanoSMD350LR-C	P	3.50	12	75	100	60	85	1.0	0.004	0.018			
nanoSMD400LR-C	S	4.00	12	85	110	70	95	1.0	0.004	0.010			
microSMD450LR-C	S	4.50	12	90	115	75	100	1.0	0.002	0.0085	Х	Х	
400CC1206LR-C	Y	4.00	21	85	110	70	95	1.0	0.004	0.010			
450CC1210LR-C	K	4.50	21	90	115	75	100	1.3	0.002	0.008			

#### Notes:

I. I<sub>hold</sub> = Hold current: maximum current device will pass without tripping in 20°C still air

2.  $V_{max}$  = Maximum voltage device can withstand without damage at rated current ( $I_{max}$ )

3.  $P_d^{=}$  Power dissipated from device when in the tripped state at 20°C still air 4.  $R_{min}^{=}$  = Minimum resistance of device in initial (un-soldered) state

- R<sub>min</sub> = Nummin resistance of device in finited (un-soldered) state
   R<sub>max</sub> = Maximum resistance of device at 20°C measured one hour after tripping or reflow Soldering of 260°C for 20 seconds
- (Values specified were determined using PCBs with 0.115in x 1.0in ounce copper traces)

Caution: Operation beyond the specified rating may result in damage and possible arcing and flame

#### Description

The Littelfuse LoRho SMD PTC for Charging Cables provides protection from heat generated due to faults within the connector such as USB-C, microUSB, and many others.

As connectors get smaller, their pin-to-pin spacings are shrinking which increases the opportunity for debris such as dust, dirt, or water to collect causing a fault. These faults can generate a tremendous amount of heat which will damage charging cables, the devices they charge, or people using them.

#### Features

- SMD compatible with reflow soldering process
- Available in small 1206 and 1210 sizes
- Up to 21Vdc and 4.5A I<sub>hold</sub>

### Benefits

- Surface mount design reduces assembly time and cost compared to leaded/strapped models
- Saves PCB space in the USB-C connector and ensures that the USB-C plug meets USB-IF dimension specifications

- Ultra low internal resistance
- Reset automatically
- Halogen-free, lead-free and RoHS compliant

#### • Well-suited for fastcharging applications up to 21Vdc and 4.5A I<sub>hold</sub>

## Put the device into the thermostatic chamber controlled at room temperature or 25°C. Apply the specified current to the device, and increase the chamber temperature at the

Thermal Cut-Off Test-

TCO and Pd Testing Method:

rate of 2°C per minute. 3. Measure the device ambient temperature when the applied current has reduced to less than 20% of initial value.

#### Power Dissipation-

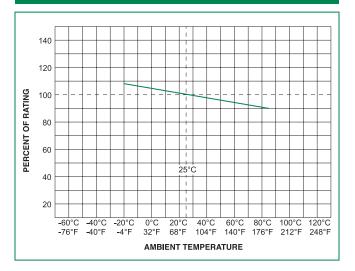
- 1. Conduct thermal cut-off test at rated current/voltage.
- 2. After device trip, decrease the chamber temperature with keeping trip state.
- Measure the tripped-state power dissipation when the device ambient temperature has reduced to 30°C or less.

### **Temperature Rerating**

Ambient OperatingTemperature									
	-20°C	0°C	20°C	60°C	85°C				
Part Number			Hold Current (A)						
nanoSMD350LR-C	4.80	4.00	3.50	1.90	1.30				
nanoSMD400LR-C	5.20	4.60	4.00	2.82	2.10				
microSMD450LR-C	6.20	5.50	4.50	3.30	2.30				
400CC1206LR-C	5.20	4.60	4.00	2.82	2.10				
450CC1210LR-C	6.20	5.50	4.50	3.30	2.30				

Note: The temperature rerating data is for reference only. Please contact Littelfuse technical support for detail temperature rerating information.

### **Temperature Derating Curve**



#### **Environmental Specifications**

Operating Temperature	-20°C to +85°C
Maximum Device Surface Temperature in Tripped State	125°C
Passive Aging	+85°C, 1000 hours -/+10% typical resistance change
Humidity Aging	+85°C, 85% R.H.,100 hours -/+15% typical resistance change
Thermal Shock	MIL–STD–202, Method 215 No change
Vibration	MIL–STD–883, Method 2007, Condition A No change
Moisture Sensitivity Level	Level 2a, J–STD–020

### **Physical Specifications**

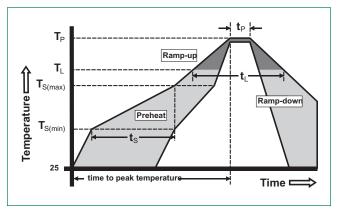
Terminal	Solder-Plated Copper
Materials	(Solder Material: Matte Tin (Sn))
Lead	Meets EIA Specification RS186-9E, ANSI/J-
Solderability	STD-002, Category 3

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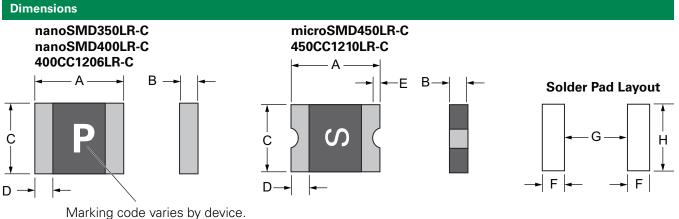
#### **Soldering Parameters**

Profile Fea	iture	Pb – Free assembly			
	-Temperature Min (T <sub>s(min)</sub> )	150°C			
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C			
	-Time (min to max) (t <sub>s</sub> )	60 – 120 seconds			
Average ra (T <sub>L</sub> ) to pea	amp up rate (LiquidusTemp k	3°C/second max			
$T_{S(max)}$ to $T_L$	- Ramp-up Rate	3°C/second max			
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C			
nellow	-Temperature (t <sub>L</sub> )	60 – 150 seconds			
PeakTemp	erature (T <sub>P</sub> )	260°C			
Time with Temperatu	in 5°C of actual peak ıre (t <sub>p</sub> )	30 seconds max			
Ramp-dov	vn Rate	2°C/second max			
Time 25°C	to peakTemperature (T <sub>P</sub> )	8 minutes max			



#### Notes:

- All temperature refer to topside of the package, measured on the package body surface.
  If reflow temperature exceeds the recommended profile, devices may not meet the
- In reliow temperature exceeds the recommended prome, devices may not meet the performance requirements.
- Recommended reflow methods: IR, vapor phase oven, hot air oven,  $\mathsf{N}_2$  environment for lead.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard industry methods and solvents.
- Devices can be reworked using the standard industry practices.



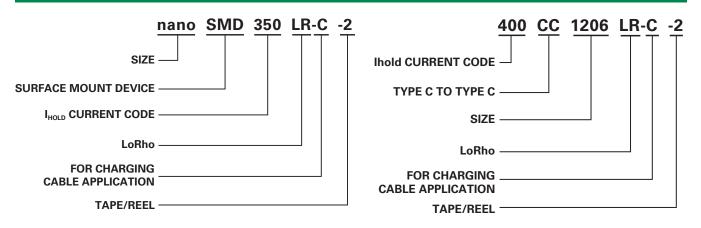
Marking code varies by device. See Electrical Characteristics table.

		Device Dimension										Solder Pad														
Part Number	A		В				С			D			E				I	=	G		Н					
Fart Number	in	ch	m	m	in	ch	m	m	in	ch	m	m	in	ch	m	m	ind	ch	m	m	inah		inch		inah	mm
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Inch	mm	Inch	mm	Inch	mm
nanoSMD350LR-C	0.12	0.13	3.00	3.43	0.02	0.03	0.60	0.80	0.05	0.07	1.37	1.85	0.01	0.03	0.25	0.75	-				0.04	1.10	0.08	2.00	0.07	1.75
nanoSMD400LR-C	0.12	0.13	3.00	3.43	0.02	0.03	0.60	0.80	0.05	0.07	1.37	1.85	0.01	0.03	0.25	0.75	-				0.04	1.10	0.08	2.00	0.07	1.75
microSMD450LR-C	0.12	0.13	3.00	3.43	0.02	0.03	0.60	0.80	0.09	0.11	2.35	2.80	0.01	0.03	0.25	0.75	0.003		0.076		0.04	1.00	0.08	2.00	0.10	2.65
400CC1206LR-C	0.12	0.13	3.00	3.43	0.02	0.03	0.50	0.80	0.05	0.07	1.37	1.85	0.01	0.03	0.25	0.75	-				0.04	1.00	0.08	2.00	0.10	2.65
450CC1210LR-C	0.12	0.13	3.00	3.43	0.02	0.03	0.50	0.80	0.09	0.11	2.35	2.80	0.01	0.03	0.25	0.75	0.003		0.076		0.04	1.00	0.08	2.00	0.10	2.65



Packaging					
Part Number	Ordering	I <sub>HOLD</sub> (A)	I <sub>HOLD</sub> Code	Packaging Option	Quantity
nanoSMD350LR-C	RF4610-000	3.50	350		15,000
nanoSMD400LR-C	RF4611-000	4.00	400		15,000
microSMD450LR-C	RF2515-000	4.50	450	Tape and Reel	15,000
400CC1206LR-C	RF4798-000	4.00	400		15,000
450CC1210LR-C	RF4800-000	4.50	450		15,000

#### Part Numbering System



#### Installation and Handling Guidelines

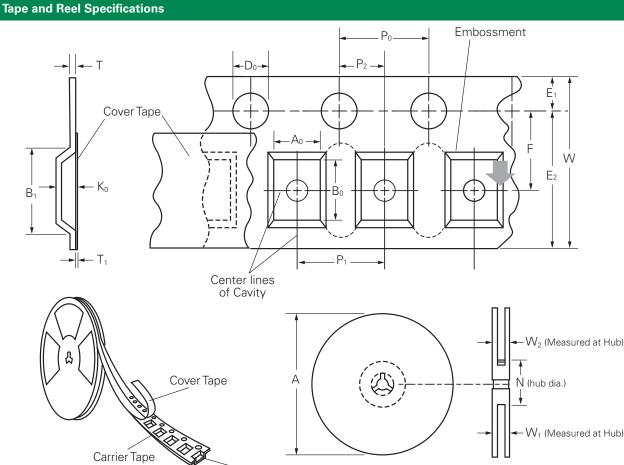
- Operation of these devices beyond the stated maximum ratings could result in damage to the devices and lead to electrical arcing and/or fire.
- These devices are intended to protect against the effects of temporary over-current or over-temperature conditions and are not intended to perform as protective devices where such conditions are expected to be repetitive or prolonged in duration.
- Exposure to silicon-based oils, solvents, electrolytes, acids, and similar materials can adversely affect the performance of these PPTC devices.
- These devices undergo thermal expansion under fault conditions, and thus shall be provided with adequate space and be protected against mechanical stresses.

- Circuits with inductance may generate a voltage (L di/dt) above the rated voltage of the PPTC device.
- Hand-soldering of PTC devices on boards is generally not recommended. Users shall define and verify this process if needed.
- Consult Littelfuse when the device is to be applied with thermal processes other than reflow process on the circuit board, such as molding, encapsulation. User should evaluate molding materials used in the charging cable applications to ensure there are no adverse effect on the PTC devices.

## POLYSWITCH® Resettable PTCs







Embossed Cavity

	nanoSMD350LR-C nanoSMD400LR-C	microSMD450LR-C
W	8.0 ± 0.30	8.0 ± 0.30
Po	4.0 ± 0.10	4.0 ± 0.10
<b>P</b> <sub>1</sub>	4.0 ± 0.10	4.0 ± 0.10
<b>P</b> <sub>2</sub>	$2.0 \pm 0.05$	$2.0 \pm 0.05$
A <sub>0</sub>	1.95 ± 0.10	2.9 ± 0.10
B <sub>0</sub>	3.50 + 0.1/-0.08	3.55 ± 0.10
B₁ max.	4.35	4.35
D <sub>0</sub>	1.55 ± 0.05	1.55 ± 0.05
F	$3.50 \pm 0.05$	$3.50 \pm 0.05$
E1	1.75 ± 0.10	1.75 ± 0.10
E₂ min.	6.25	6.25
T max.	0.3	0.3
T₁ max.	0.1	0.1
K <sub>0</sub>	0.89 ± 0.10	1.27 ± 0.10
A max.	179	179
N min.	53.5	53.5
<b>W</b> <sub>1</sub>	$9.5 \pm 0.5$	9.5 ± 0.5
W₂ max.	15	15

Standard Pack Quantity: 3,000 pcs Minimum Order Quantity: 15,000 pcs

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